

Semiconductor Monitoring Burn-in Test Chamber **ETSP-BTC** series

Technical Specification

Model	Internal dimensions	External dimensions	Note
ETSP-BTC 1000	1250 × 650 × 1300 (W × D × H) mm	2250 × 1500 × 2500 (W × D × H) mm	Manual door
ETSP-BTC 2000	1250 × 650 × 1300 (W × D × H) mm	2300 × 1600 × 2600 (W × D × H) mm	Automatic door

- **Controller** Touch screen LCD programmable type (6,000 step, 300 profile)
- **No. of zones** 1
- **No. of slots for BIB (Burn in Board)** 48 (In case of BIB size is 450 X 571 X 1.6t (W X D mm))
- **Refrigeration** cooling system for refrigeration or fresh air or cooled water
- **Inside material** STS304, 1.2t, polishing
- **Exterior material** CR 2.0t, painting
- **Safety devices** Switch-off after alarm for Overheating, Current leak, Over current, Door open (ELB, BKM, OHP, E-Stop Switch, Tower lamp)

Options

- Chart recorder
- T/C (Thermal couple) data acquisition (8, 16, 24, 32 Ch)
- Chamber networking connection system (RS422/RS485)
- Customization available